



## Material Content Data Sheet



Sales Product Name	BF 1009S E6327			Issued		14. October 2015		
MA#	MA000770648							
Package	PG-SOT143-4-1			Weight*		11.07 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	noble metal	gold	7440-57-5	0.004	0.03		348	
	non noble metal	tin	7440-31-5	0.001	0.01		90	
	inorganic material	silicon	7440-21-3	0.029	0.26	0.30	2582	3020
leadframe	non noble metal	nickel	7440-02-0	1.673	15.11		151101	
	non noble metal	iron	7439-89-6	2.310	20.87	35.98	208663	359764
wire	noble metal	gold	7440-57-5	0.017	0.15	0.15	1539	1539
encapsulation	organic material	carbon black	1333-86-4	0.104	0.94		9415	
	inorganic material	antimonytrioxide	1309-64-4	0.156	1.41		14123	
	plastics	brominated resin	-	0.195	1.77		17654	
	plastics	epoxy resin	-	1.629	14.71		147117	
	inorganic material	silicondioxide	60676-86-0	4.430	40.02	58.85	400158	588467
leadfinish	non noble metal	tin	7440-31-5	0.219	1.98	1.98	19811	19811
plating	noble metal	silver	7440-22-4	0.303	2.74	2.74	27399	27399
*deviation	< 10%	Sum in total:			100.00		1000000	

### Important Remarks:

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